

PCN Number:	20231220000.2		PCN Date:	December 22, 2023			
Title:	Adding CD-PR as additional wafer probe site						
Customer Contact:	Change Management Team		Dept:	Quality Services			
Proposed 1st Ship Date:	June 20, 2024	Estimated Sample Availability:	Samples not supported				
Change Type:							
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site					
<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material					
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process					
<input type="checkbox"/> Mechanical Specification	<input checked="" type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site					
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials					
		<input type="checkbox"/> Wafer Fab Process					
PCN Details							
Description of Change:							
Texas Instruments Incorporated has qualified CD-PR as additional probe site for the devices listed below to support high volume ramps.							
<div> <div>Current:</div> <div>New:</div> </div> <table border="1"> <tr> <td>Probe Site</td> <td>DL-LIN</td> <td>TICDAT(CD-PR)</td> </tr> </table>					Probe Site	DL-LIN	TICDAT(CD-PR)
Probe Site	DL-LIN	TICDAT(CD-PR)					
Test coverage, insertions, conditions will remain consistent with current testing.							
Reason for Change:							
These changes are part of our multiyear plan to transition products from our 150-millimeter factories to newer, more efficient manufacturing processes and technologies, underscoring our commitment to product longevity and supply continuity.							
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):							
None.							
Changes to product identification resulting from this PCN:							
None.							
Product Affected:							
DAC7562SQDGSRQ1	LM43603AQPWPTQ1	LM53602AQPWPTPA	LM76005QRNPRQ1				
DAC7563SQDGSRQ1	LM43603QPWPRQ1	LM53602AQPWPTQ1	OPA2180QDGKRQ1				
DAC8162SQDGSRQ1	LM43603QPWPTQ1	LM536033QPWPRQ1	OPA2188AQDGKRQ1				
DAC8163SQDGSRQ1	LM46000AQPWPRQ1	LM536033QPWPTQ1	OPA2313QDGKRQ1				
DAC8562SQDGSRQ1	LM46000AQPWPTQ1	LM536035QPWPRQ1	OPA2313QDRQ1				
DAC8563SQDGSRQ1	LM46000QPWPRQ1	LM536035QPWPTQ1	OPA314AQDBVRQ1				
DRV425QWRTJRQ1	LM46000QPWPTQ1	LM53603AQPWPRQ1	OPA314AQDBVTQ1				
LM43600AQPWPRQ1	LM46001AQPWPRQ1	LM53603AQPWPTQ1	OPA4171AQDRQ1				
LM43600AQPWPTQ1	LM46001AQPWPTQ1	LM53603BQPWPRDN	OPA4171AQPWRQ1				
LM43600QPWPRQ1	LM46001QPWPRQ1	LM73605QHTRNPRAP	OPA4314AQPWRQ1				
LM43600QPWPTQ1	LM46001QPWPTQ1	LM73605QHTRNPTAP	PM536025QPWPTQ1				
LM43601AQPWPRQ1	LM46002AQPWPRQ1	LM73605QRNPRQ1	SN65HVDA100QDRKN				
LM43601AQPWPTQ1	LM46002AQPWPTQ1	LM73605QRNPTQ1	SN65HVDA100QDRQ1				
LM43601QPWPRQ1	LM46002QPWPRQ1	LM73605QURNPRQ1	TLV314QDBVRQ1				
LM43601QPWPTQ1	LM46002QPWPTQ1	LM73606QRNPRQ1	TLV314QDBVTQ1				
LM43602AQPWPRQ1	LM53601MQUDSXRQ1	LM73606QRNPTQ1	TLV4314QPWRQ1				
LM43602AQPWPTQ1	LM536023QPWPRQ1	LM73606QURNPRQ1	TMP107BQDQ1				
LM43602QPWPRQ1	LM536023QPWPTQ1	LM76002QRNPRQ1	TMP107BQDRQ1				

LM43602QPWPTQ1	LM536025QPWPRQ1	LM76002QRNPTQ1	TPS40170QRGYRQ1
LM43602SPWPRQ1	LM536025QPWPTQ1	LM76003QRNPRQ1	UCC28070QPWRQ1
LM43602SPWPTQ1	LM53602AQPWPRPA	LM76003QRNPTQ1	
LM43603AQPWPRQ1	LM53602AQPWPRQ1	LM76005HTQRNPRQ1	

ZVEI ID: SEM-TF-01

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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